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Radiative heat transfer at nanoscale mediated by surface plasmons for highly doped silicon.

Emmanuel Rousseau *, Marine Laroche, and Jean-Jacques Greffet
Laboratoire Charles Fabry
Institut d'Optique, CNRS, Université Paris-sud
2 av Fresnel
91127 Palaiseau cedex, France

In this letter, we revisit the role of surface plasmons for nanoscale radiative heat transfer between doped silicon surfaces. We derive a new accurate and closed-form expression of the radiative near-field heat transfer. We also analyse the flux and find that there is a doping level that maximizes the heat flux.

Radiative heat transfer at nanoscale can be orders of magnitude larger than predicted by Stefan's law. This is now well-known and well documented¹⁻¹². Several groups have reported experimental evidence of the effect of the enhancement of the flux^{13,14}. More recently, the effect has been investigated in the nanometer regime¹⁵⁻¹⁷. Finally, experimental measurements with a well-controlled geometry in the nanometer regime have confirmed the theoretical predictions^{18,19}. These experiments have been performed for silica taking advantage of the strong contribution of surface phonon polaritons to the nanoscale radiative heat transfer predicted in ref.^{11,12}. In this paper, we discuss the contribution of surface plasmons to the nanoscale radiative heat transfer. It is well-known that surface plasmons do not play any role in the heat transfer between two parallel metallic surfaces because they cannot be excited thermally. Indeed, typical energies of surface plasmons are larger than 2 eV. However, when dealing with highly doped silicon, the surface plasmon frequency is in the infrared. This effect was extensively analysed by Fu and Zhang²⁰. In this paper, we report a detailed analysis of the contribution of the surface plasmon to the nanoscale heat transfer. We derive an accurate asymptotic closed-form expression of this contribution. Finally, we show that the flux can be maximized by properly choosing the doping. The heat transfer coefficient is then found to be on the same order of magnitude than for silica and much larger than for metals. The system considered in this letter consists of a gap separating two homogeneous half spaces. Doped silicon is characterized by its local isotropic dielectric constant. It includes an intrinsic contribution denoted ε_{int} and the carrier contribution which can be either electrons (e) or holes (h). The intrinsic contribution is found from optical data at room temperature²¹. The carrier contribution is given by a Drude model²⁰.

The plates temperatures are supposed to be uniform and noted T and $T + \delta T$. We will assume that $\delta T/T \ll 1$ so that we can introduce a heat transfer coefficient $\varphi(d, T) = h(d, T)\delta T$ where $\varphi(d, T)$ is the radiative flux

per unit area. The radiative heat transfer coefficient can be cast in the form^{3,7-9,11} :

$$h(d, T) = \sum_j \int_0^\infty du [h_j^{prop}(u, T, d) + h_j^{evan}(u, T, d)] \quad (1)$$

where $u = \hbar\omega/k_B T$, *prop* and *evan* stand respectively for propagating and evanescent waves and $j = s, p$ stands for the polarization. The coefficients are given by:

$$h_j^{prop}(u, d, T) = h_0(u) \int_0^{\omega/c} \kappa d\kappa \left(\frac{c}{\omega}\right)^2 \times \frac{(1 - |r_{31}^j|^2)(1 - |r_{32}^j|^2)}{|1 - r_{31}^j r_{32}^j e^{2i\gamma d}|^2} \quad (2)$$

$$h_j^{evan}(u, d, T) = h_0(u) \int_{\omega/c}^\infty \kappa d\kappa \left(\frac{c}{\omega}\right)^2 \times \frac{4 \operatorname{Im}(r_{31}^j) \operatorname{Im}(r_{32}^j)}{|1 - r_{31}^j r_{32}^j e^{-2\operatorname{Im}[\gamma]d}|^2} e^{-2\operatorname{Im}[\gamma]d} \quad (3)$$

$h_0(u)$ is the derivative of the Planck function: $h_0(u) = \frac{\partial L}{\partial T}(u) = \frac{3}{2\pi^2} \frac{g_0}{\lambda_T^2} u^4 \frac{e^u}{(e^u - 1)^2}$ with $g_0 = \pi^2 k_b^2 T / 3h$ the quantum of thermal conductance and $\lambda_T = \hbar c / k_b T$ the thermal wavelength. The Fresnel coefficients are given by : $r_{3m}^s = \frac{\gamma - \gamma_m}{\gamma + \gamma_m}$ and $r_{3m}^p = \frac{\varepsilon_m(\omega)\gamma - \gamma_m}{\varepsilon_m(\omega)\gamma + \gamma_m}$, where 3 denotes the vacuum and m stands for one of the two plates $m = 1, 2$. p means Transverse Magnetic (*TM*) polarization and s Transverse Electric (*TE*). γ is the normal component of the wave vector in the gap and γ_m is the wave vector in the media defined as $\gamma_m = \sqrt{\varepsilon_m(\omega)(\omega/c)^2 - \kappa^2}$. To compute the total flux, it is necessary to add the contributions of all the modes by integrating over κ and ω .

As an example, we plot in Fig.1 the heat transfer coefficient versus the distance for a doping level equal to $N_e = 2.10^{19} \text{ cm}^{-3}$. Two features appear clearly. It is seen that the contribution of s-polarized evanescent waves first increases and then saturates as the gap width decreases. On the other hand, the contribution of the p-polarized evanescent waves varies as d^{-2} and dominates for gaps smaller than 50 nm. This contribution does not exist for intrinsic silicon. It can be attributed to the contribution of the surface plasmon polariton associated

*Electronic mail: emmanuel.rousseau@institutoptique.fr

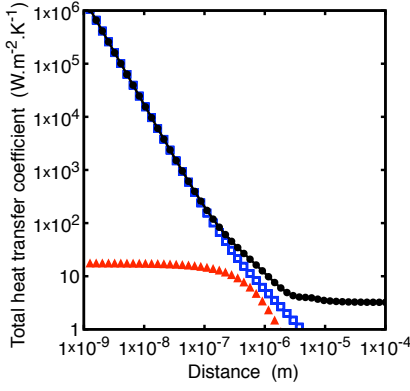


FIG. 1: Colors are available on-line. Total heat transfer coefficient at high doping level: $N_e = 2.10^{19} \text{ cm}^{-3}$. Dot black curve: Total heat transfer coefficient. Red triangles curve: s-polarization evanescent waves contribution. Blue square curve: p-polarization evanescent waves contribution. The temperature is $T = 300 \text{ K}$.

with the free carriers as discussed in refs^{3,5,9,12,20}. To support this assumption, we plot $A = \frac{4Im[r_p]^2 e^{-2\gamma''l}}{|1-r_s^2 e^{-2\gamma''l}|^2}$ in the (ω, κ) domain in Fig.2.

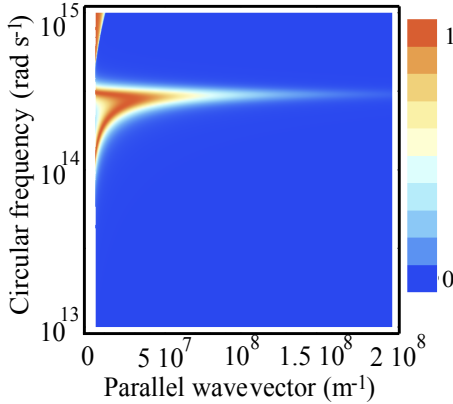


FIG. 2: Colors are available on-line. Ratio A in the plane (ω, κ) . Doping concentration is $N_e = 10^{20} \text{ cm}^{-3}$. The two lines result from the coupling of surface-plasmon polaritons (SPP) on both interfaces. The lines coincide with the dispersion relation of the SPP for the two interfaces system. The gap is $d = 10 \text{ nm}$ and the temperature is $T = 300 \text{ K}$.

The leading contribution to the heat transfer is confined along two lines. Their shape is given by the dispersion relation of the surface plasmon polariton in the two-interfaces geometry. This behaviour is similar to polar materials which support surface phonon-polariton. The ratio A tends to zero for wave-vectors larger than $1/d$ because in that case, the surface plasmon on both interfaces no longer overlap. A quantitative estimate of the contribution of the coupled Surface Plasmon Polariton $h_p^{spp}(d, T)$ can be derived by noting that the parallel

wavevector satisfies $\kappa \gg \omega/c$. Hence, the Fresnel coefficients become independent of the parallel wave vector κ : $\tilde{r}_p = \frac{\epsilon(\omega)-1}{\epsilon(\omega)+1}$ so that the integration over κ can be performed with the help of the second-order polylogarithm function²²:

$$h_p^{spp}(u, d, T) = \frac{3}{2\pi^3} \frac{g_0}{d^2} \frac{Im(\tilde{r}_{31}^p)Im(\tilde{r}_{32}^p)}{Im(\tilde{r}_{31}^p \tilde{r}_{32}^p)} \times Im[Li_2(\tilde{r}_{31}^p \tilde{r}_{32}^p)] u^2 \frac{e^u}{(e^u - 1)^2}, \quad (4)$$

This closed-form expression (eq.4) is general and also applies when the doping is different for the two plates. It accounts for the temperature dependence and the doping dependence. In order to compare it with the exact numerical result of Eq.(3), we define the thermal conductance $\delta G(N_e, T)$ as:

$$h_p^{spp}(d, T) = \frac{\delta G(N_e, T)}{d^2}. \quad (5)$$

$\delta G(N_e, T)$ is compared with the exact numerical result in Fig.3. In contrast with previous approximate formulas^{5,11,20}, the new asymptotic expression describes accurately the surface mode contribution for a large range of doping levels $10^{16} \leq N_e \leq 10^{21} \text{ cm}^{-3}$ and temperatures $100 \leq T \leq 1000$.

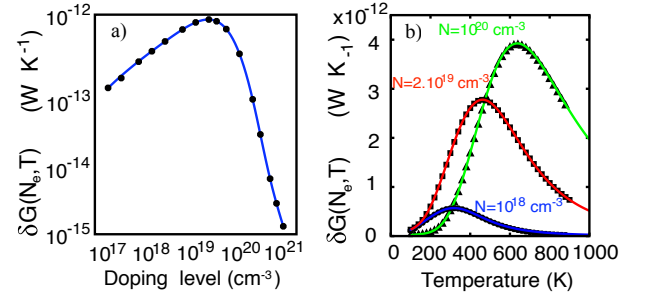


FIG. 3: Colors are available on-line. Comparison between the closed-form expression (plain line) of $\delta G(N_e, T)$ and the exact numerical integration (symbols). a) Dependence on doping at $T = 300 \text{ K}$. b) Dependence on temperature for three doping concentrations.

Changing the doping level can increase the SPP contribution by several orders of magnitude as seen in Fig.3-a. Fig.3-b shows that whatever the doping level is, a maximum is found for a precise temperature. However tuning the temperature changes $\delta G(N_e, T)$ by less than one order of magnitude. In order to maximize the near-field radiative heat transfer, we plot $\delta G(N_e, T)$ versus N_e and T (Fig.4). It is seen that there is a maximum for $N_e \simeq 10^{20} \text{ cm}^{-3}$ and $T \simeq 600 \text{ K}$ corresponding to $3.910^{-12} \text{ WK}^{-1}$. This has the same order of magnitude than SiC at 300K ($9.110^{-13} \text{ WK}^{-1}$) or silica at 300K ($2.810^{-12} \text{ WK}^{-1}$).

Finally, we note that the heat transfer coefficient can be viewed as the quantum of thermal conductance g_0

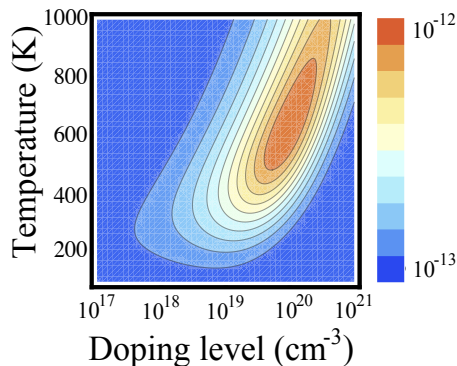


FIG. 4: Colors are available on-line. Evolution of $\delta G(N_e, T)$ with temperature and doping level. $\delta G(N_e, T)$ is maximal for temperature $T \simeq 600K$ and doping level $N_e = 10^{20} \text{ cm}^{-3}$.

times the number of modes per unit area. As expected the number of modes is proportional to λ_T^{-2} in the far field regime (eq.2). The $1/d^2$ dependance of the radiative heat transfer coefficient in the near-field regime (eq.4) comes from the number of modes per unit area contributing to the heat transfer.

In summary, we have derived an asymptotic closed-form expression for the nanoscale heat transfer coefficient mediated by surface plasmons. We showed that the heat transfer coefficient for doped silicon depends on doping and temperature. It has a maximum that can be as large as for polar materials.

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